

# The most versatile instrument for a materials scientist?

It is a microscope that produces an image by using an electron beam that scans the surface of a specimen inside a vacuum chamber.

What can we study in a SEM?

- Topography and morphology
- Chemistry
- Crystallography
- Orientation of grains
- In-situ experiments:
  - Reactions with atmosphere
  - Effects of temperature

“Easy” sample preparation!!

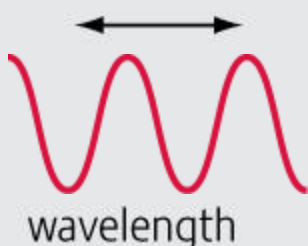
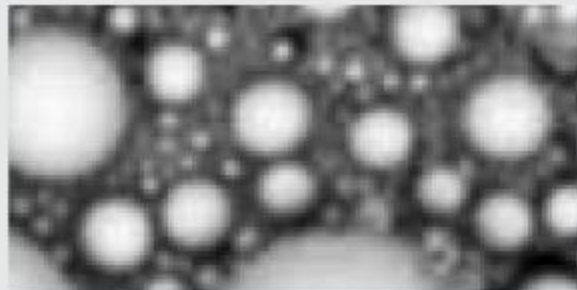
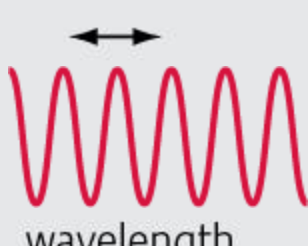
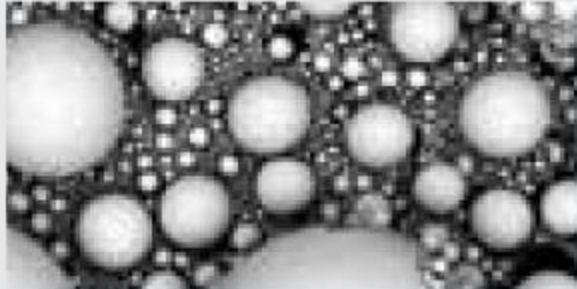
“Big” samples!

# Optical Microscope versus Electron Microscope

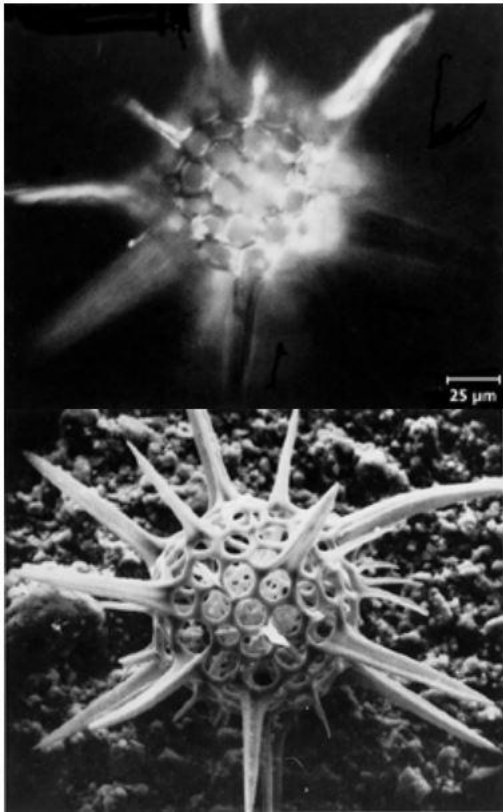
	LIGHT MICROSCOPE	ELECTRON MICROSCOPE
<i>The source of illumination</i> ▶	The ambient light source is light for the microscope	Electrons are used to “see” - light is replaced by an electron gun built into the column
<i>The lens type</i> ▶	Glass lenses	Electromagnetic lenses
<i>Magnification method</i> ▶	Magnification is changed by moving the lens	Focal length is changed by changing the current through the lens coil
<i>Viewing the sample</i> ▶	Eyepiece (ocular)	Fluorescent screen or digital camera
<i>Use of vacuum</i> ▶	No vacuum	Entire electron path from gun to camera must be under vacuum

	Magnifications	Depth of Field	Resolution
OM:	4x – 1400x	0.5mm	~ 0.2mm
SEM:	10x – 500Kx	30mm	1.5nm

# How is Resolution Affected by Wavelength?

<p>low frequency</p>	 <p>wavelength</p>	<p>poor resolution</p> 
<p>high frequency</p>	 <p>wavelength</p>	<p>good resolution</p> 

# Electronic Microscope for higher resolution



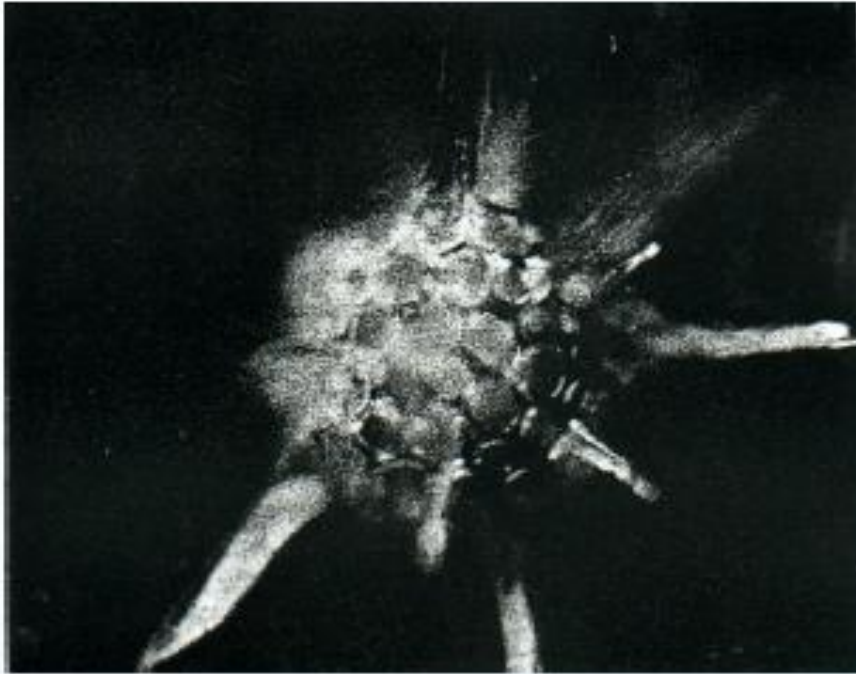
- Resolution limit of optical microscopes is due to the light diffraction; roughly optical resolution can be estimated as wavelength  $\lambda/2NA$  (NA is the numerical aperture of lens, usually  $\sim 1.0$ ): for white light, average wavelength is around 500 nm, the best resolution is thus a few hundreds nm.

- Decreasing the wavelength is the way to improve the resolution.

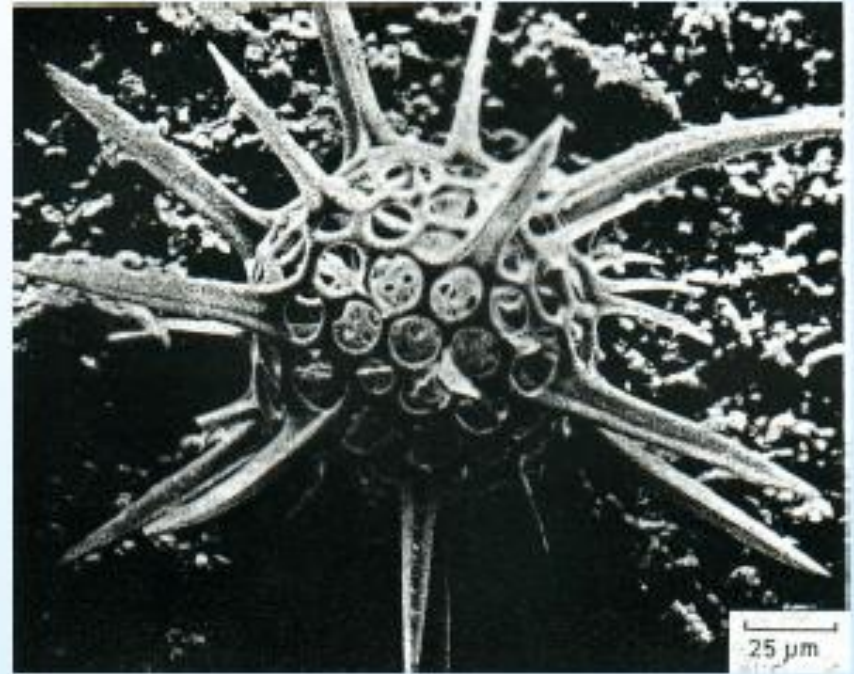
• Electron wave is a unique medium that can be used in imaging. By accelerating the electrons into high energy beam (via high voltage), the wavelength thus created is far shorter than white light. For example, for an electron beam produced from a 20 kV gun, the wavelength is only  $1240.7/20,000$  (eV) = 0.06 nm = 0.6 Å, corresponding to a resolution limit of  $\lambda/2 = 0.3$  Å --- theoretically, it can be used to image a species as small as 0.3 Å. Most atoms are in size of 2-3 Å.

# Scanning Electron Microscopy

## Image Quality



Optical Microscope



SEM

SEM is very useful for examining objects at a wide range of magnifications, compared to optical microscope.



# Electron Microscopy

SEM



A standard SEM is typically used for low-to-medium magnification (10-150,000X) imaging of conductive samples, usually metals.

For non-conductive samples, a conductive coating of carbon, gold, chromium, etc. should be applied to avoid charging effects.

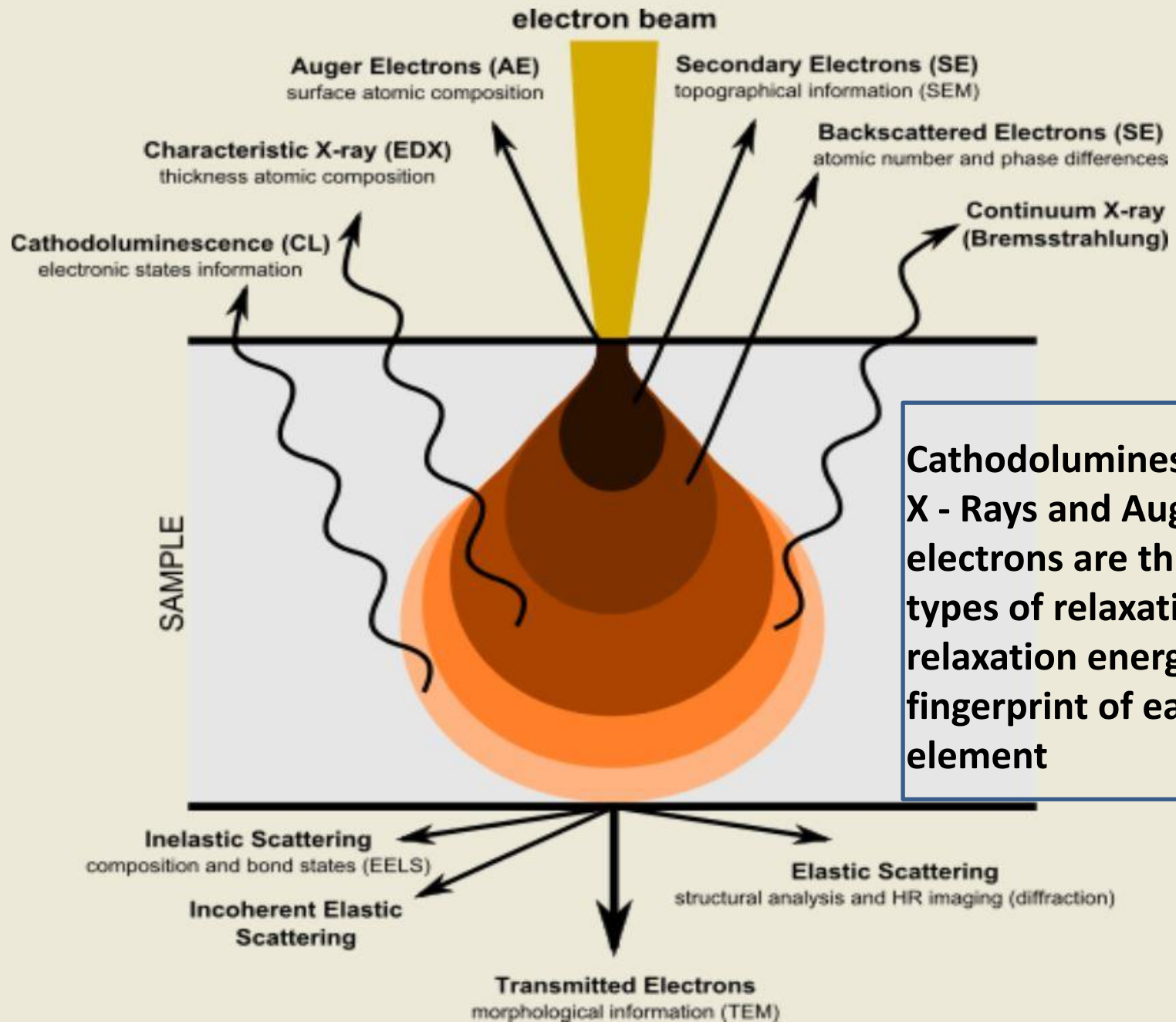
A variable pressure SEM (low vacuum or environmental) is used for non-conductive specimens like glass, polymers/paint, and biological materials.

A field-emission SEM (FESEM) is used for medium-high magnification (20,000- 800,000X) and high resolution at low electron beam accelerating voltages (0.5-2 kV) resulting in excellent surface texture images even on non-conductive materials.

FESEM



# Signals from the sample



Cathodoluminescence, X - Rays and Auger electrons are three types of relaxation. The relaxation energy is the fingerprint of each element

# Scanning Electron Microscopy

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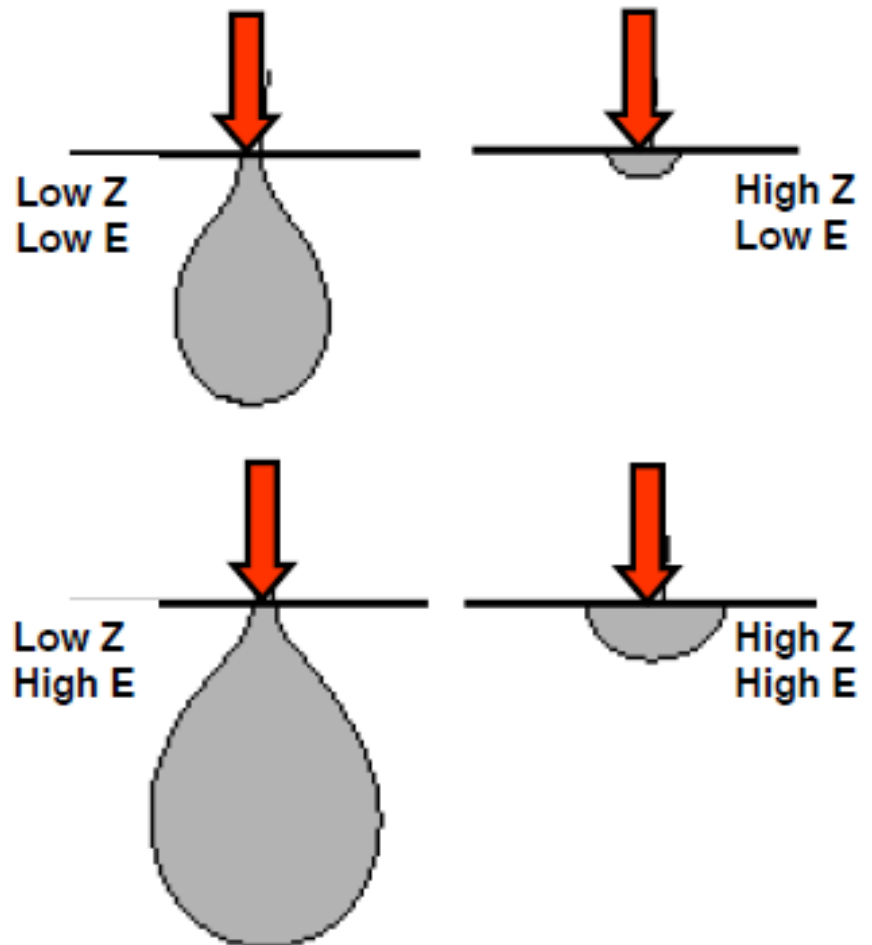
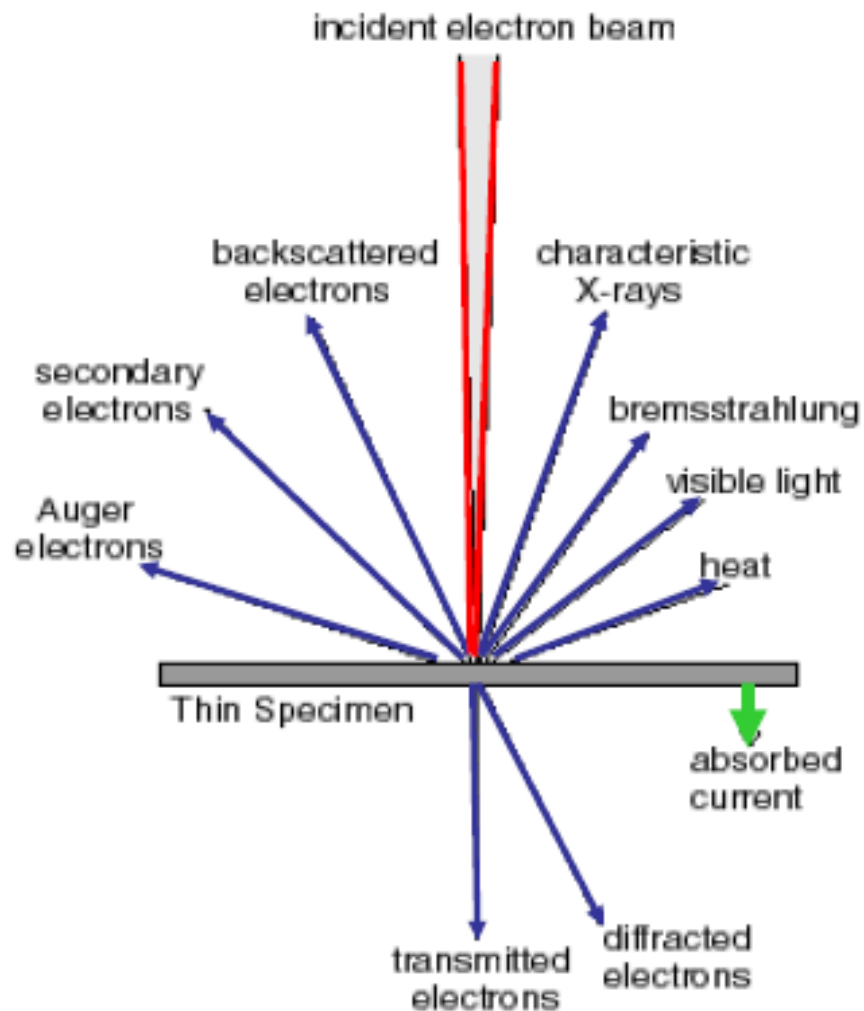
The variety of electron induced signals that are produced in the SEM can provide

- ▶ Morphological (surface topography)
- ▶ Composition (chemical information)
- ▶ Physical Info (structural, electrical)

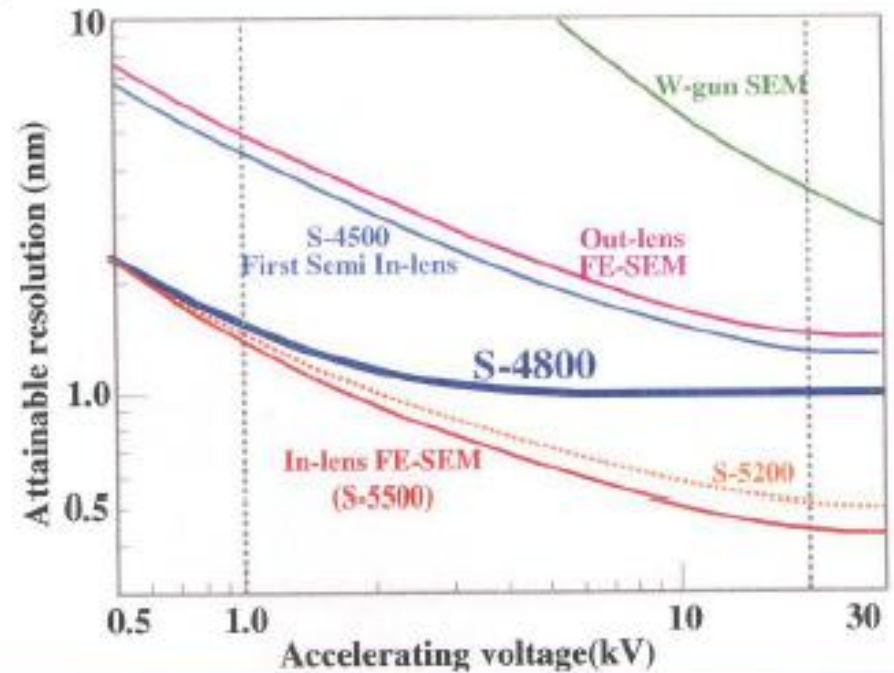
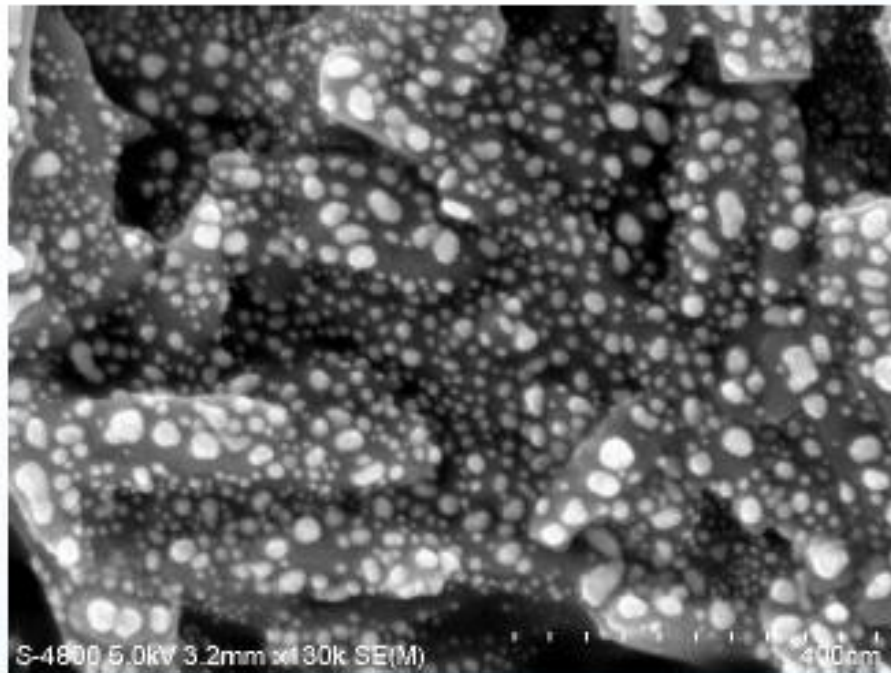




# Electron Interaction with Solids



# Resolution of SEMs

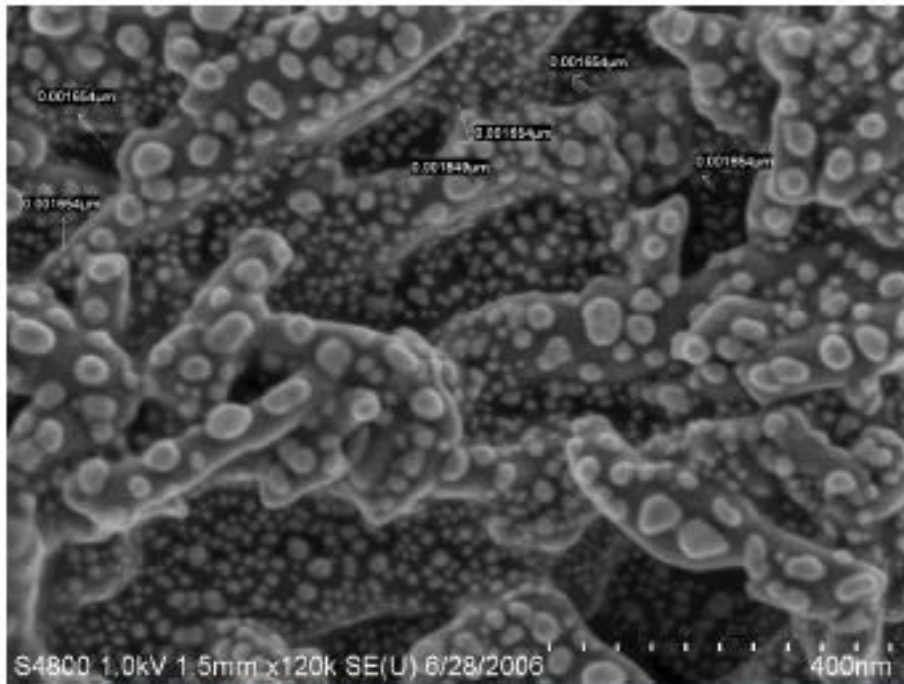


SEM provides high image magnification and resolution!

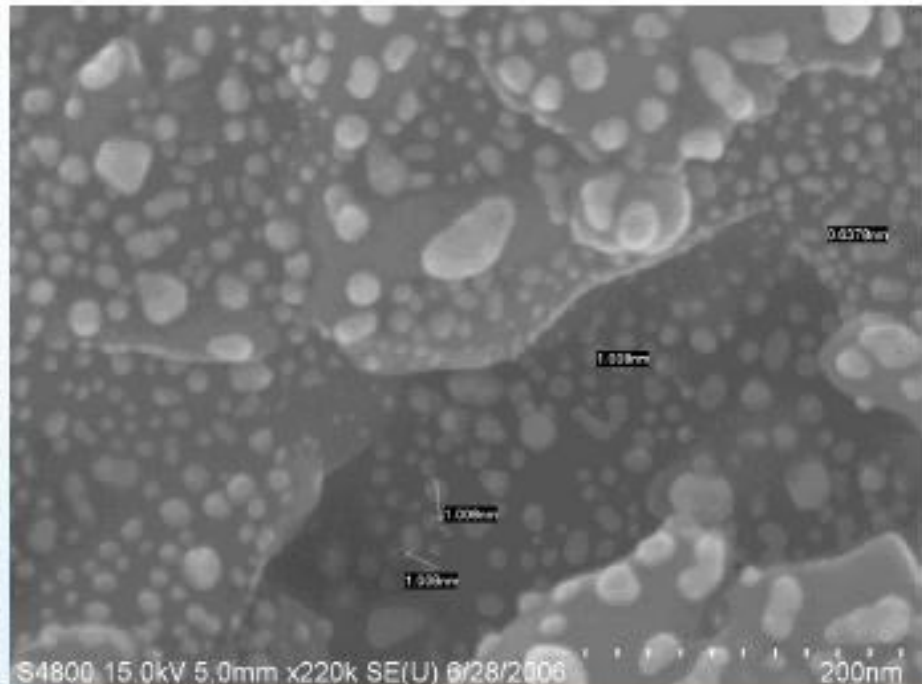
5.0 nm ( $50 \text{ \AA}$ ) - common for commercial instruments

2.0 nm ( $20 \text{ \AA}$ ) - for Advanced Research instruments

# FESEM Resolution



1.0 KV



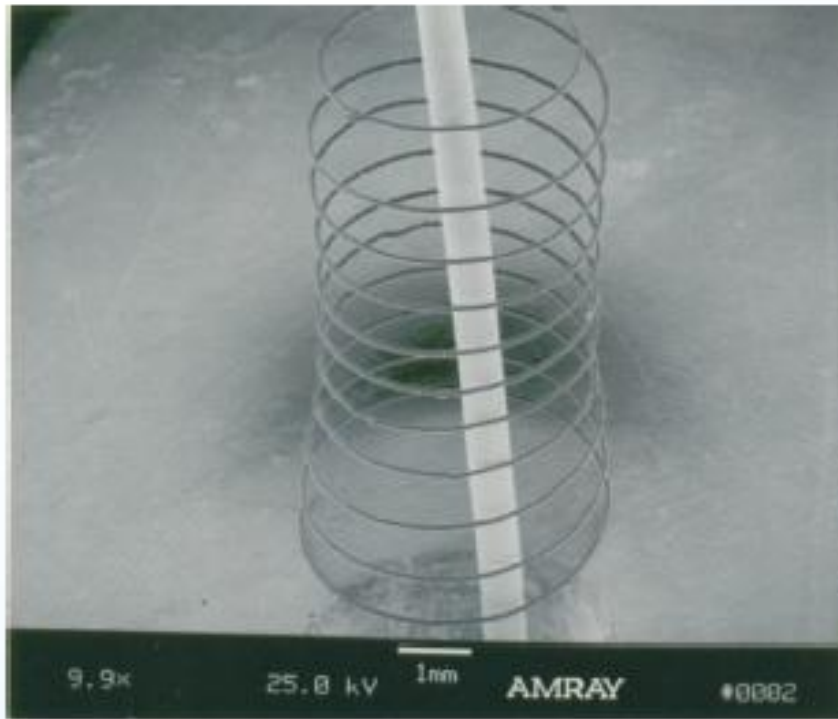
15.0 KV

Field-emission SEMs are superior!

Resolution of 1.0 nm can be easily attained.



# 3-D View of SEM Images



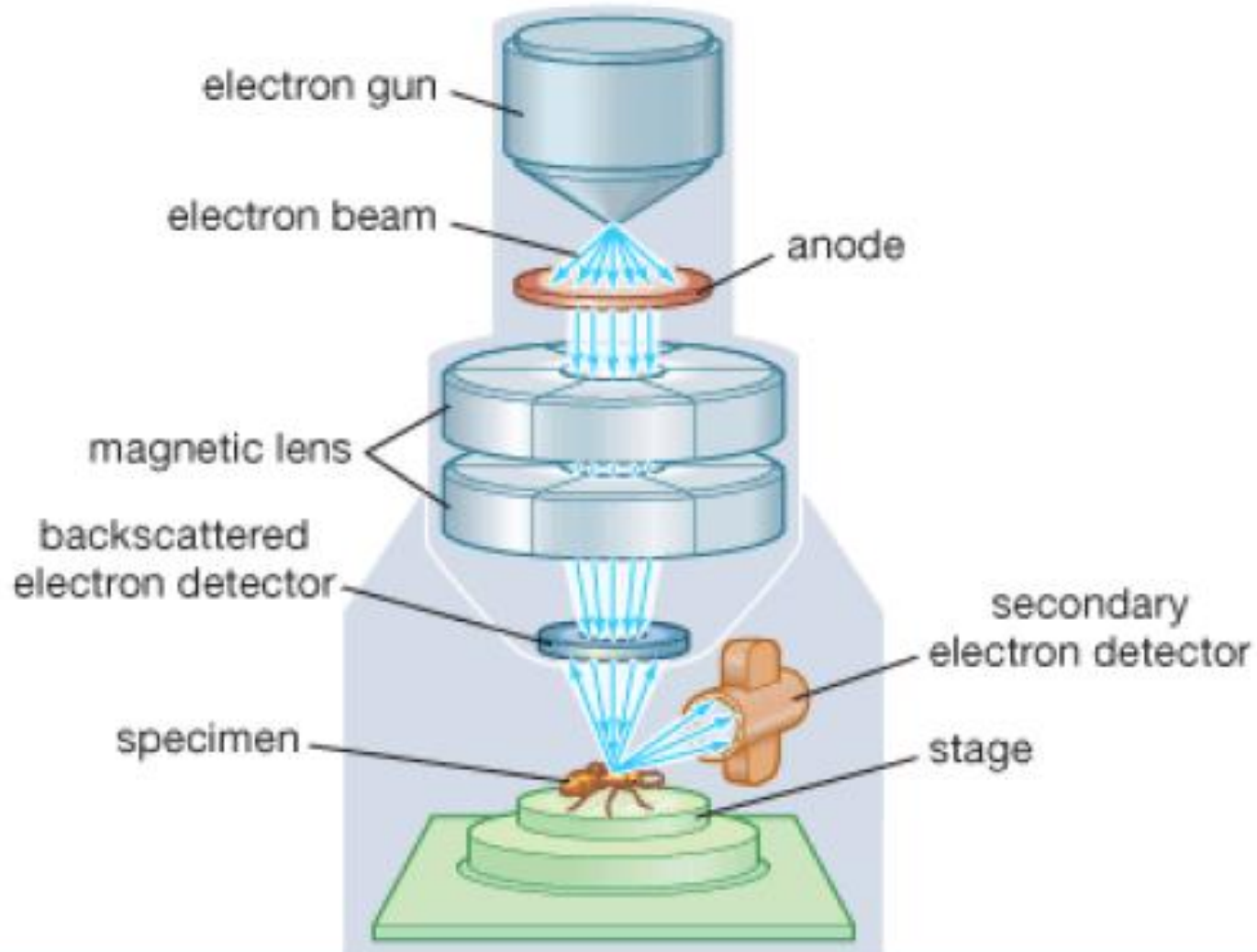
Large DOF provides more info about the specimen, and makes it easy to interpret the image.

# Basic Components of SEM

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- ▶ **Electron gun assembly** -  
This produces a stable source of primary electron beam.
- ▶ **Electromagnetic lenses and apertures** -  
These focus the electron beam on the specimen.
- ▶ **Vacuum system** -  
This allows the passage of the electrons through the column without the interference of air molecules.
- ▶ **Electron collector, signal detection and display components, and recording CRT – Imaging.**
- ▶ **Specimen Goniometer Stage** -  
moving the sample under the electron beam.

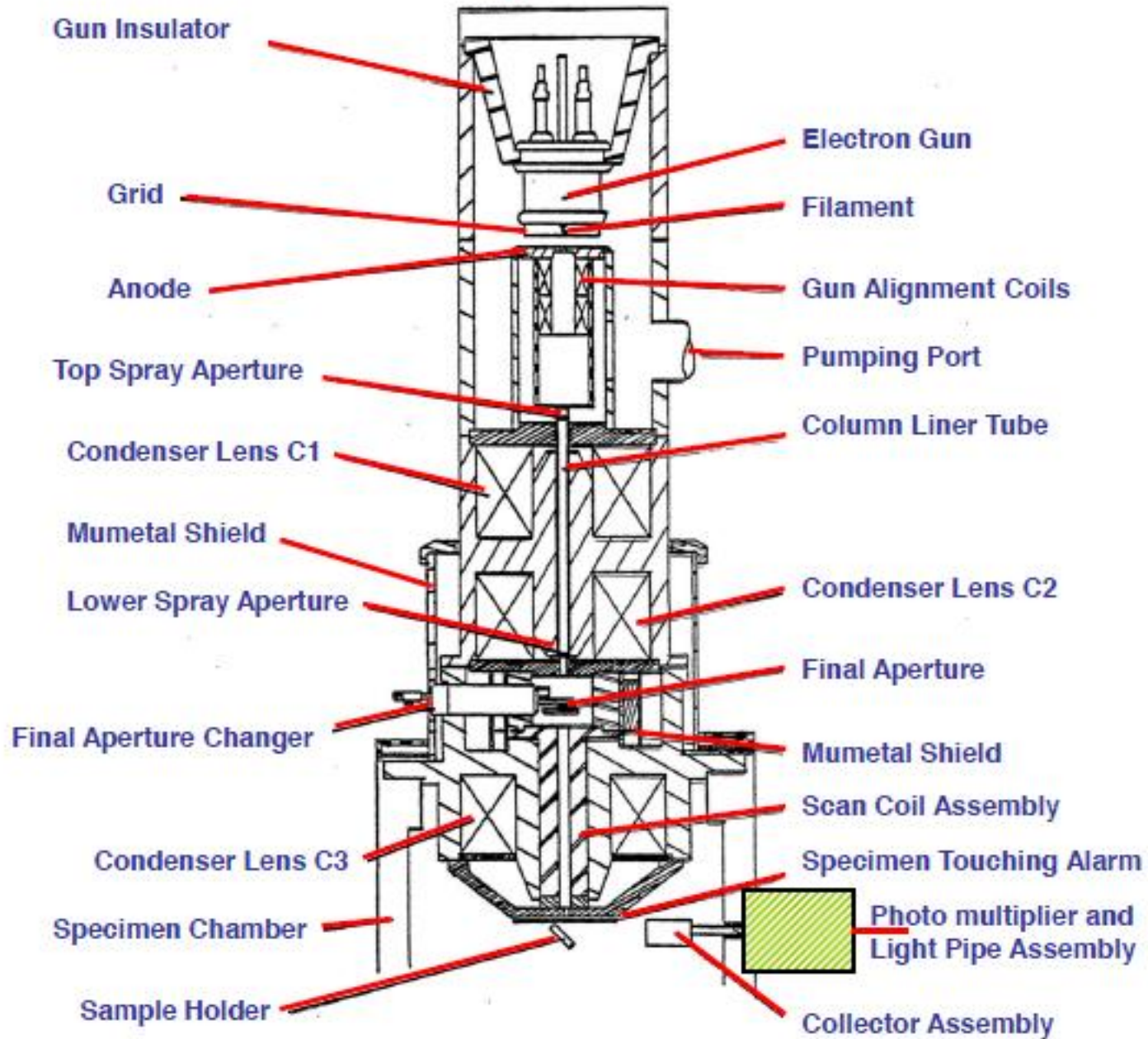
# The instrument in brief



- Electron microscope follows the same ideas of optical microscope, but uses electrons instead of light;
- “Lens” here are not the optical materials (like glass), but electrical field.



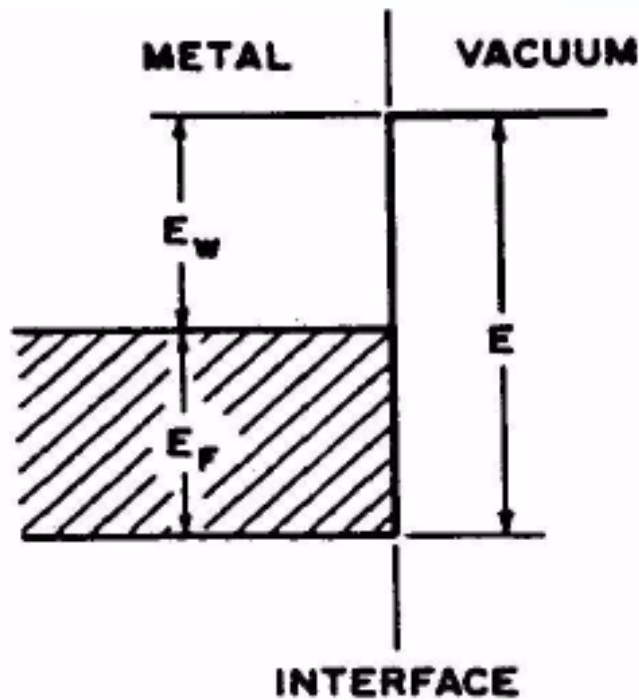
# Electron Optical Column





# Concept of Work Function

## Energy Model of Thermionic Emission



$$E_W = E - E_F$$

The emission current density is given by Richardson equation

$$J_c = A_c T^2 \exp(-E_W/kT) \text{ A/cm}^2$$

$$A_c - (\text{A/cm}^2 \text{K}^2); T - (\text{K})$$

At sufficiently high temperatures, a certain % of the electrons become sufficiently energetic to overcome the work function ( $E_W$ ) of the cathode material and escape the source.

# Electron Guns

- We want many electrons per time unit per area (high current density) and as small electron spot as possible
- Traditional guns: thermionic electron gun (electrons are emitted when a solid is heated)
  - W-wire, LaB<sub>6</sub>-crystal
- Modern: field emission guns (FEG) (cold guns, a strong electric field is used to extract electrons)
  - Single crystal of W, etched to a thin tip

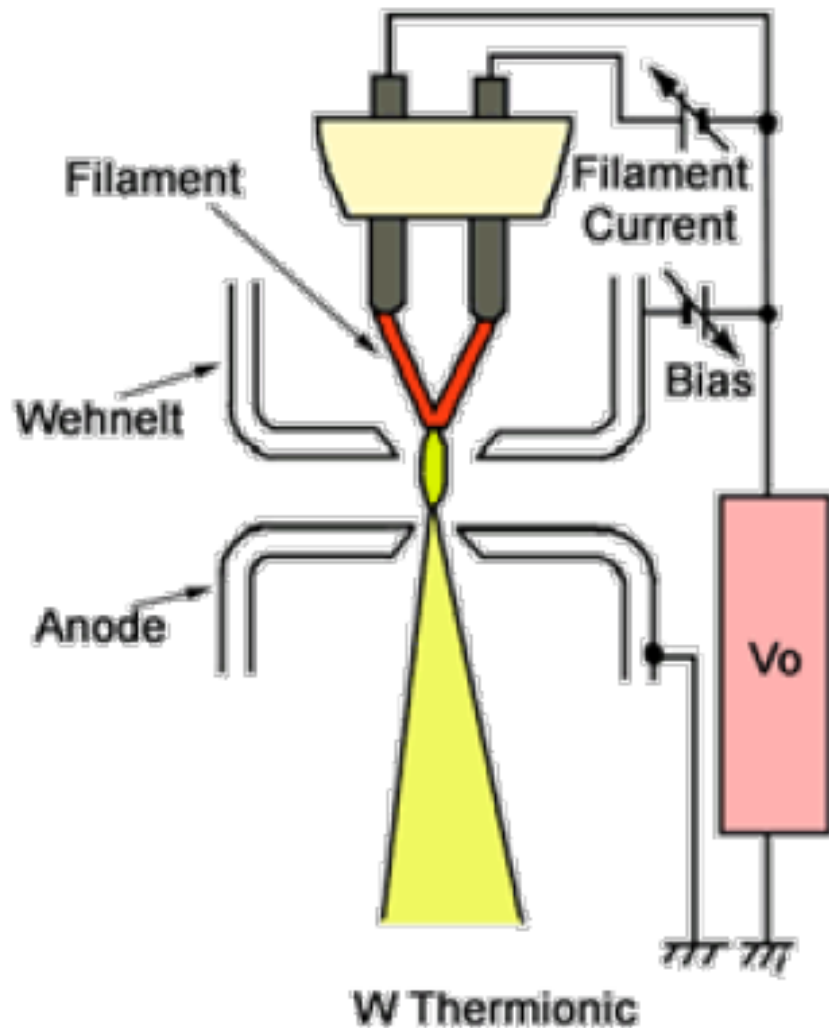
Table 1 summarizes the features of these electron guns.

Table 1 Features of three electron guns.

	TE gun		FE gun	SE gun
	Tungsten	LaB <sub>6</sub>		
Electron-source size	15 ~ 20 μm	10 μm	5 ~ 10nm	15 ~ 20nm
Brightness (Acm <sup>-2</sup> rad <sup>-2</sup> )	10 <sup>5</sup>	10 <sup>6</sup>	10 <sup>8</sup>	10 <sup>8</sup>
Energy spread (eV)	3 ~ 4	2 ~ 3	0.3	0.7 ~ 1
Lifetime	50 h	500 h	Several years	1 to 2 years
Cathode temperature (K)	2800	1900	300	1800
Current fluctuation (per hour)	<1%	<2%	>10%	<1%

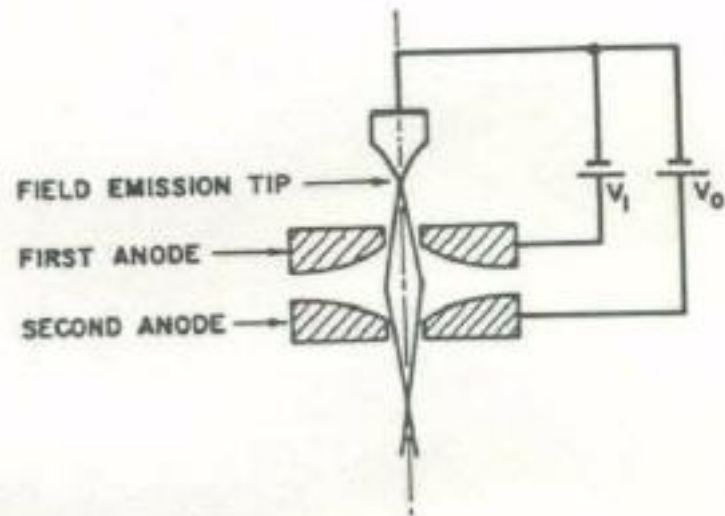
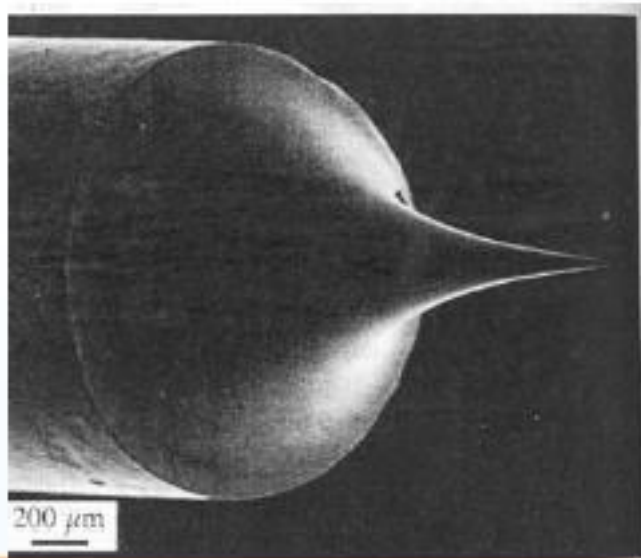
Note that the brightness is obtained at 20 kV.

# Thermionic Emission Electron Source



The most common emitter material for the electron beam is tungsten (W) or LaB6. The emitter is located at the top of the SEM column in the Gun assembly. The filament sits inside a housing called the Wehnelt cap. A potential is created between the sample and the gun and when the emitter is heated to a certain temperature electrons will begin streaming from the tip of the emitter and travel down the column. The electron beam is focused and defocused by the use of electromagnetic lenses.

# Field Emission Gun



The effective source or crossover size ( $d_0$ ) of a field emitter is approx. 10 nm, as compared to  $\text{LaB}_6$  (10  $\mu\text{m}$ ), and W (50  $\mu\text{m}$ ).

No further demagnifying lenses are needed to produce an electron probe suitable for high resolution SEM.

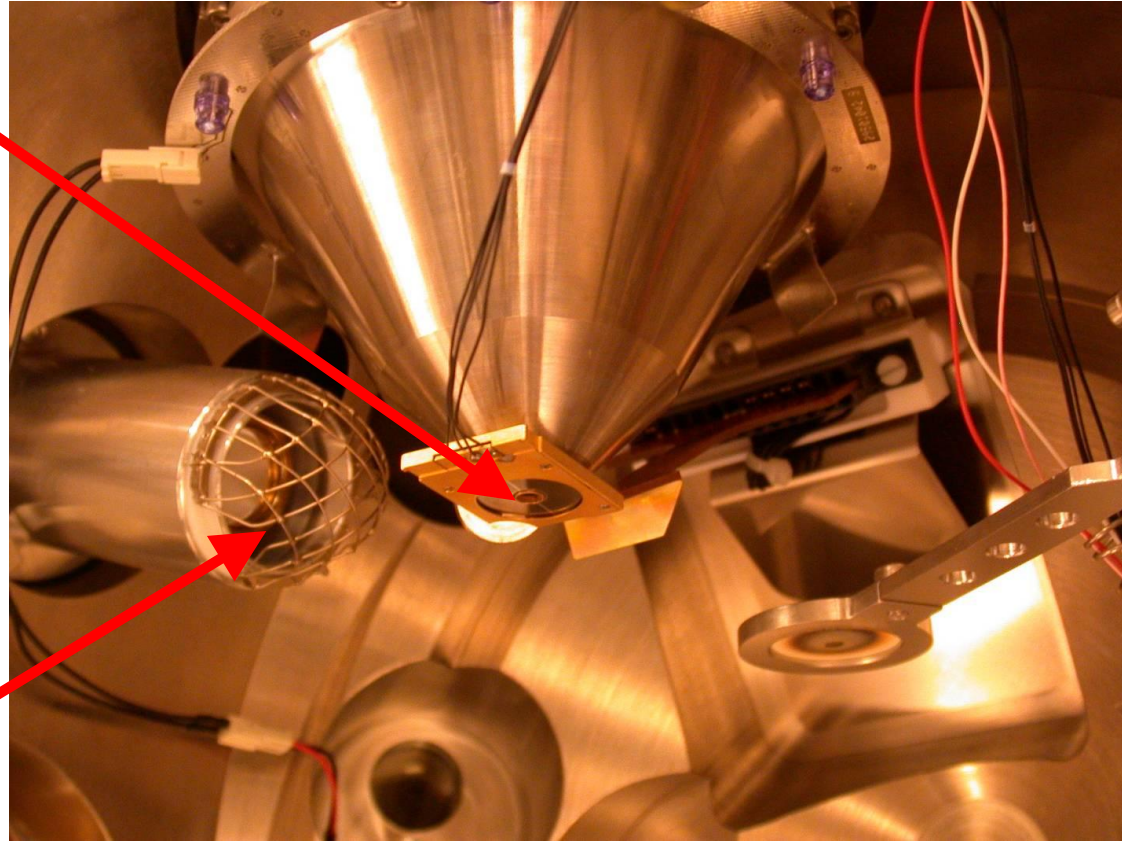


# Detectors

## Our traditional detectors

Backscattered electron detector:  
(Solid-State Detector)

Secondary electron detector:  
(Everhart-Thornley)



- Secondary electrons: Everhart-Thornley Detector
- Backscattered electrons: Solid State Detector
- X-rays: Energy dispersive spectrometer (EDS)

# Tuning Electron Current

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In SEM, a focused beam of high energy electrons scans across the surface of the specimen.

The amount of current in the focused e-beam impinging on a specimen, determines the magnitude of the signals emitted.

The size of the final probe or beam determines the best possible resolution for many of the measured signals.

The electron optical system in SEM is designed so that maximum possible current is obtained in the smallest possible electron probe.

# SE & BSE images

## **Secondary electron (SE) images**

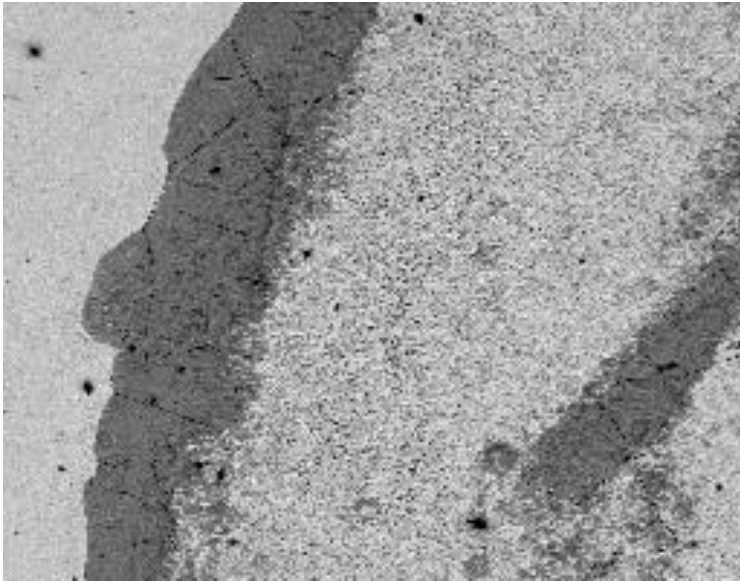
Secondary electrons are low energy electrons formed by inelastic scattering and have energy of less than 50eV. The low energy of these electrons allows them to be collected easily. This is achieved by placing a positively biased grill on the front of the SE detector, which is positioned off to one side of the specimen. The positive grill attracts the negative electrons and they go through it into the detector. This is the case for the Everhart-Thornley detector which is most commonly used but there is another kind of In-lens SE detector in some machines. The major influence on SE signal-generation is the shape (topography) of the specimen surface

## **Backscattered electron (BSE) images**

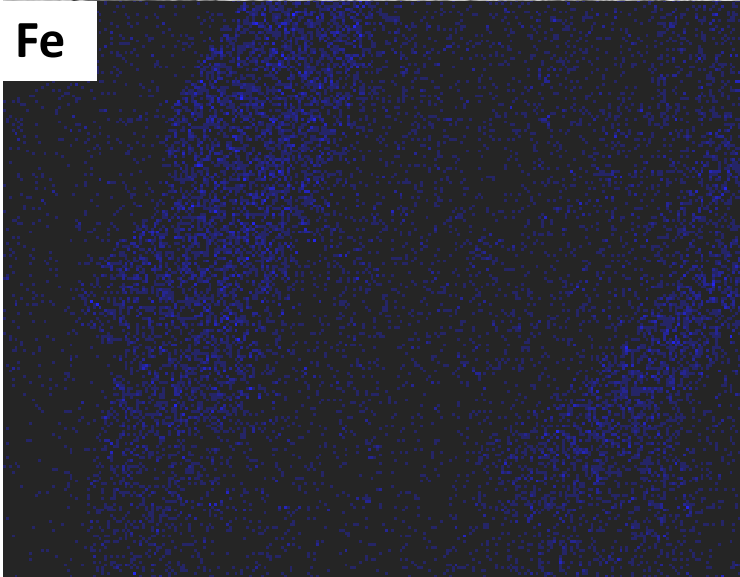
Backscattered (BS) electrons are high-energy electrons (>50 eV) from the primary incident beam that are ejected back out from the sample. These BSE are used to produce a different kind of image. Such an image uses contrast to tell us about the average atomic number of the sample. For example, a grain of sand that is made up of a titanium mineral looks whiter than a grain made of a silicon material (Ti versus Si). There is a difference in contrast between the grains labelled Si and Ti whereas in images taken using secondary electrons, there is no difference in contrast between these grains. The sample is a mixture of mineral sand.

# Chemistry

Images: Harald Fjeld, UiO

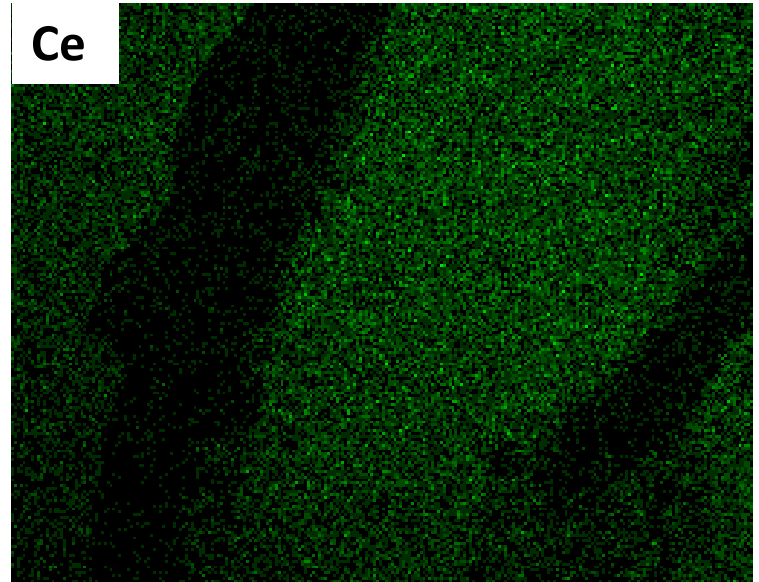


Fe

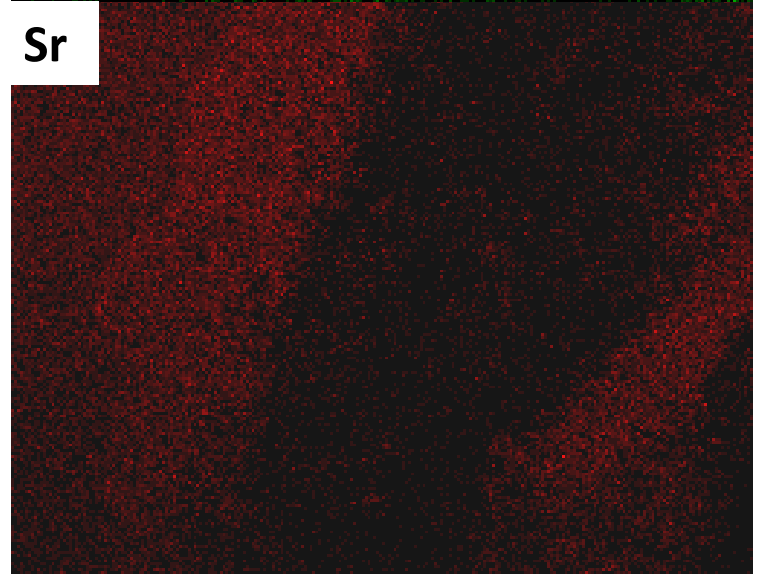


MENA3100

Ce



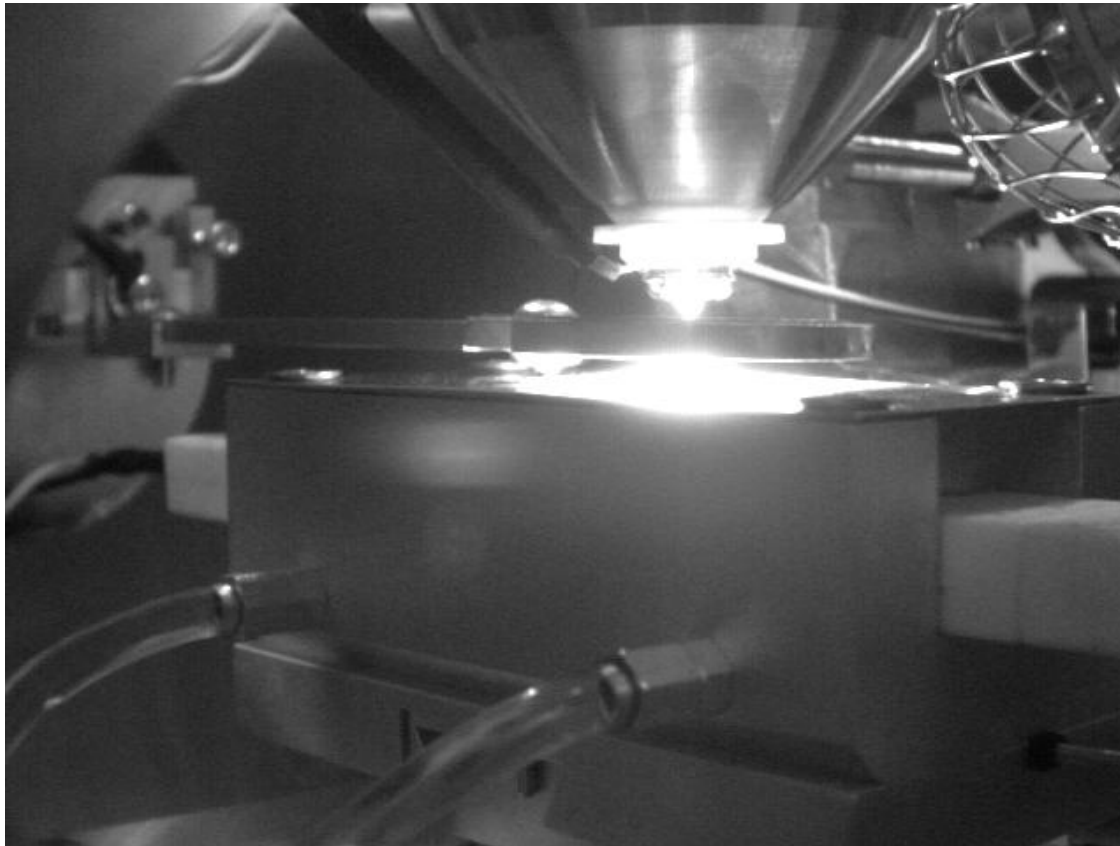
Sr





# In-situ imaging

- A modern SEM can be equipped with various accessories, e.g. a hot stage



## Operating parameters affecting signal quality

Accelerating Voltage

Probe Current

Working Distance

Specimen Tilt

Aperture Size

Edge effect

Contamination

Charging

Operating Parameter		Values
Gun voltage		~20 keV
Working distance		~26 mm
Probe size	W filament	~30 Å
	LaB <sub>6</sub>	
	Field Emission	
Vacuum	W filament	10 <sup>-5</sup> Torr
	LaB <sub>6</sub>	10 <sup>-8</sup> Torr
	Field Emission	10 <sup>-10</sup> Torr

- Probe current ↓ ➤ Probe diameter ↓ ➤ Resolution ↑
- This leads to decrease in image intensity ⇒ we have to use a brighter source  
(*W filament < LaB<sub>6</sub> < Field Emission gun*)

# Increasing Resolution

↓ Probe size

↑ strength of condenser lens

↓ Working Distance

Probe Current

*Leads to ↑ Beam convergence angle ⇒ ↑ spherical aberration*

Working Distance

Specimen Tilt

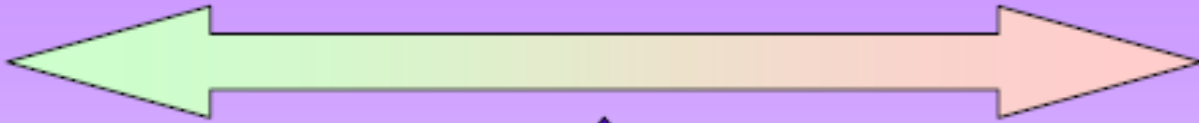
Aperture Size

Edge effect

Contamination

Charging





**Accelerating  
Voltage**

▪ High Resolution

▪ Unclear surface structures  
▪ More edge effect  
▪ More charge-up  
▪ More damage

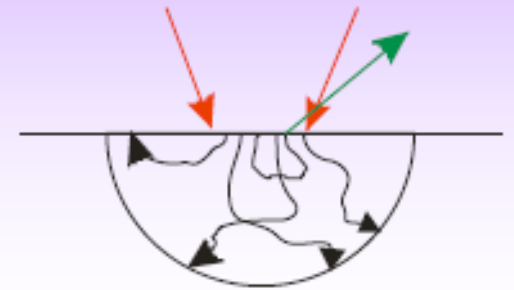
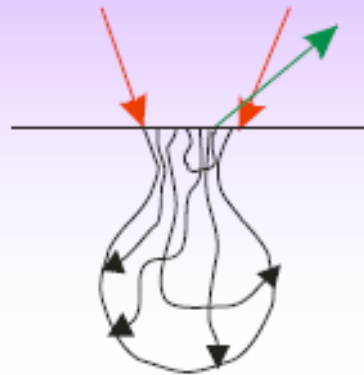
▪ Clear surface structures  
▪ Less damage  
▪ Less charge-up  
▪ Less edge effect

▪ Low resolution

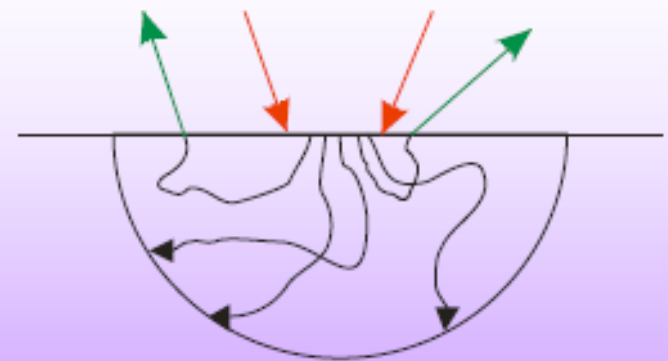
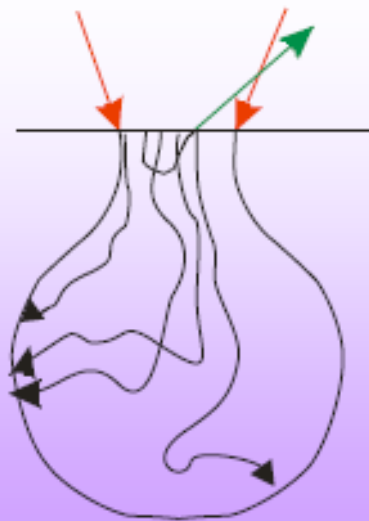
Low atomic number

High atomic number

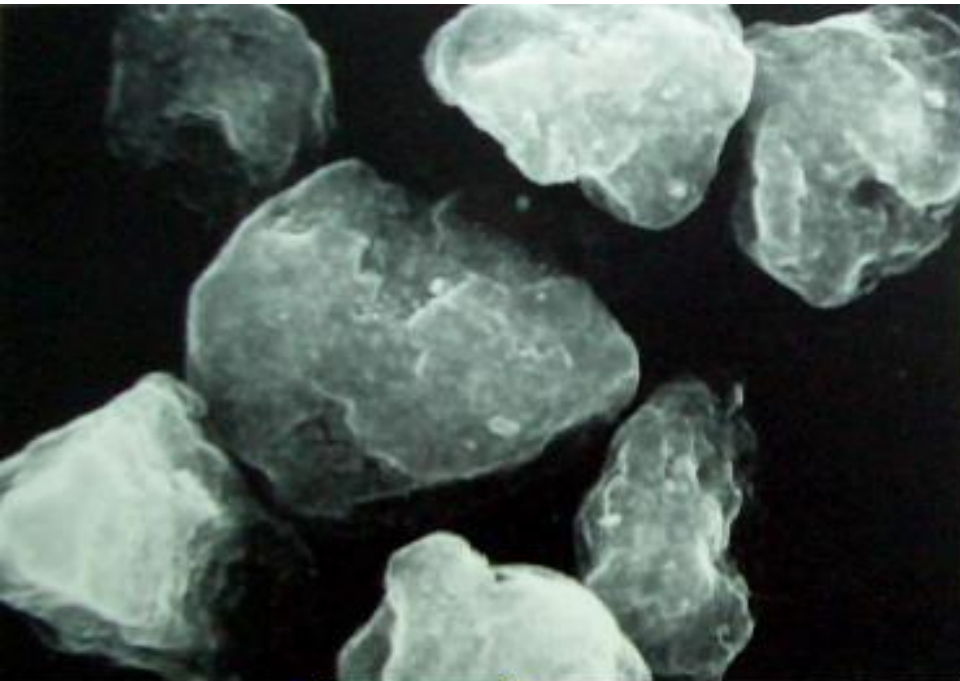
Low  
accelerating  
voltage



High  
accelerating  
voltage

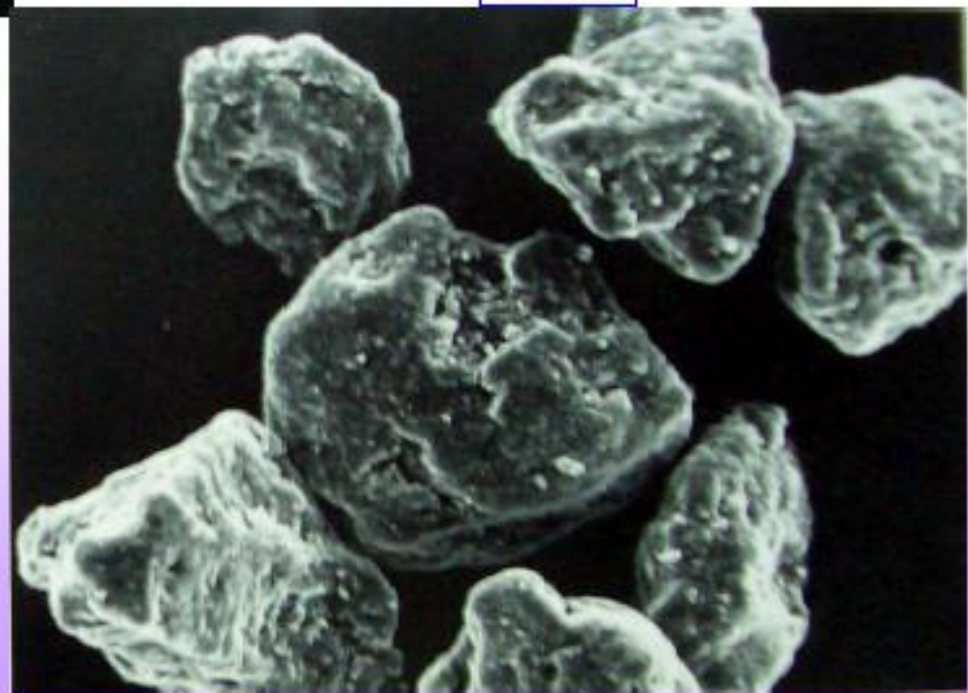


2500 ×



30 kV

5 kV



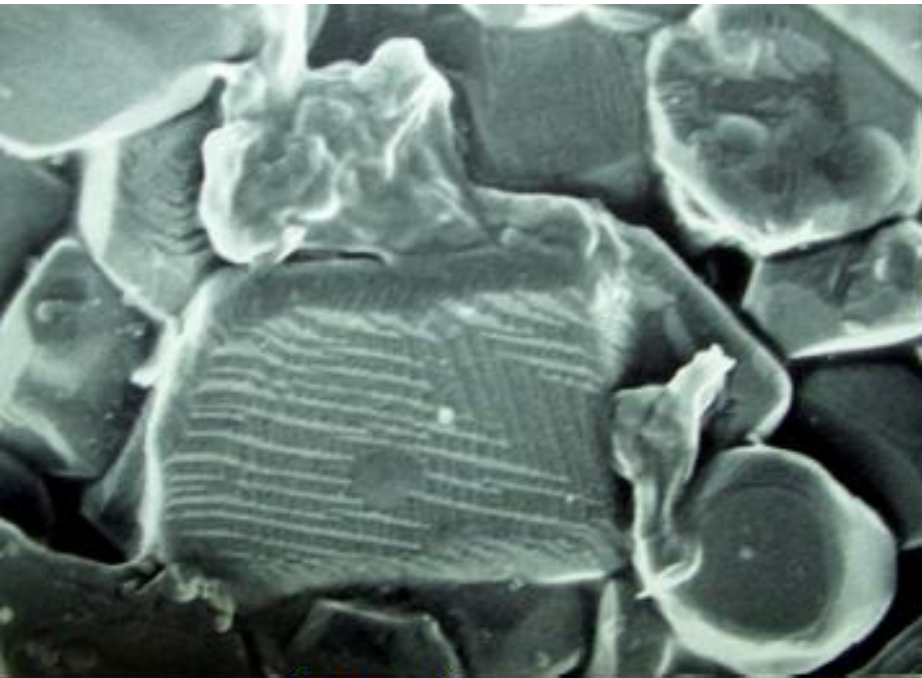
*Specimen: Toner*

↑ Accelerating voltage

→ Increased contribution of BSE

➤ Low surface contrast

➤ Charging



5 kV

*Specimen: Sintered powder*

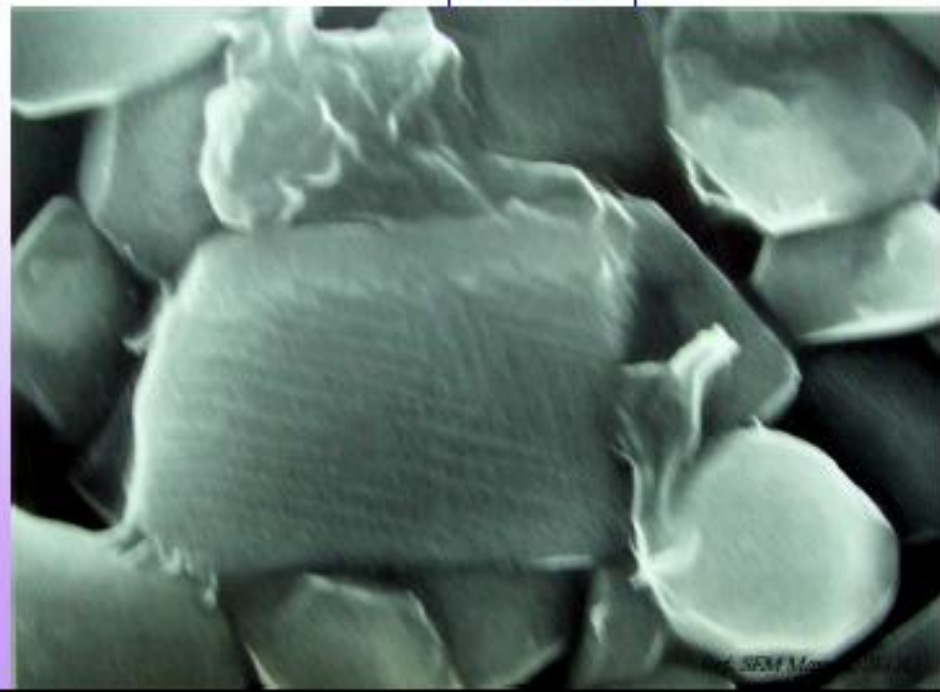
↓ Accelerating voltage

- Better surface contrast
- Not sharp at high magnifications

⇒ ↓ *WD* or ↓ *probe diameter*

7200 ×

25 kV





36000 ×



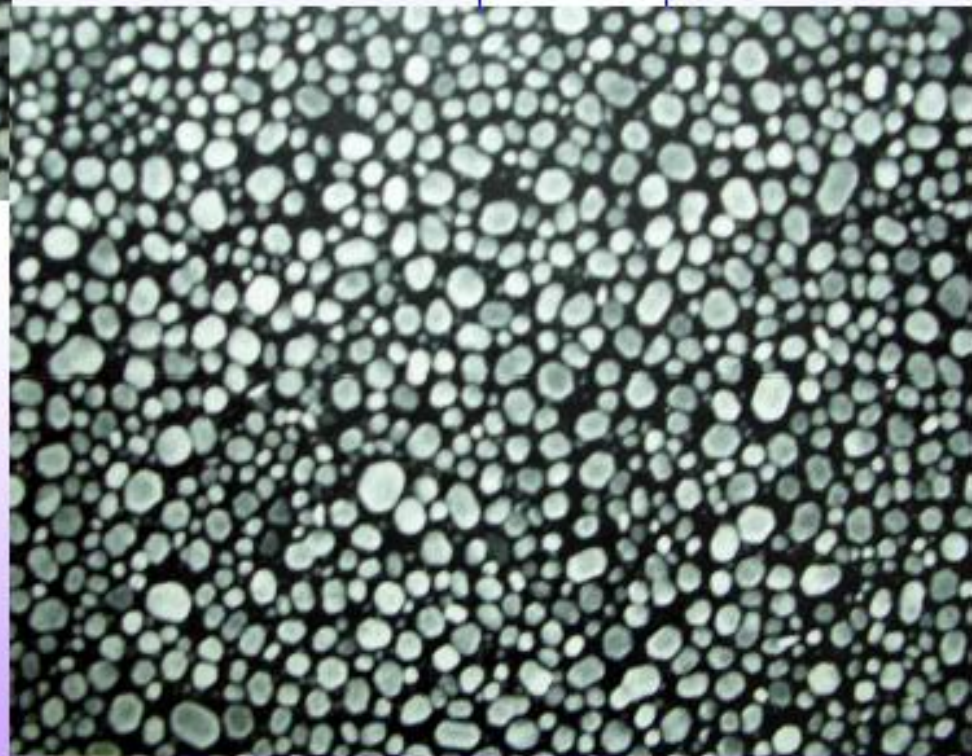
5 kV

*Specimen: Evaporated Au particles*

↑ Accelerating voltage

- Better image sharpness
- Improved resolution

25 kV

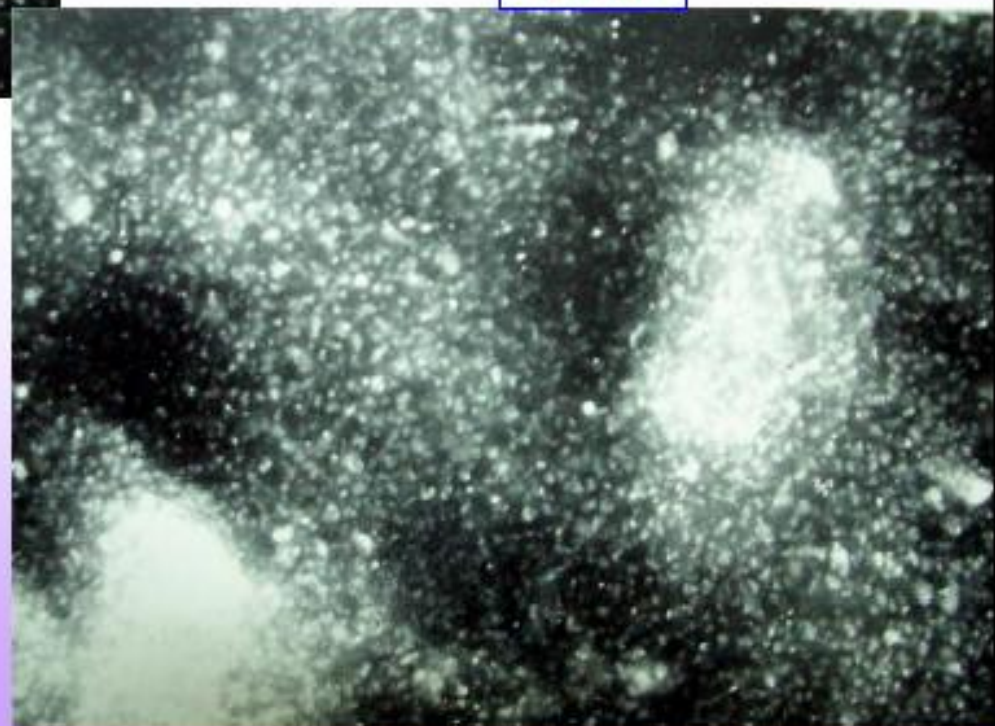


2500 ×



5 kV

25 kV

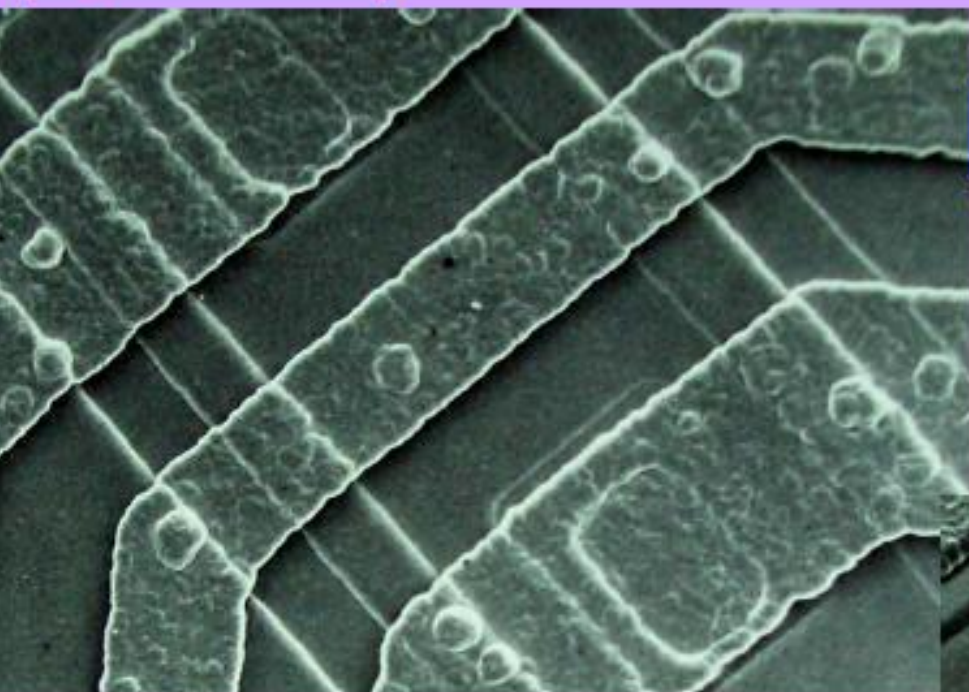


*Specimen: Paint coat*

↑ Accelerating voltage

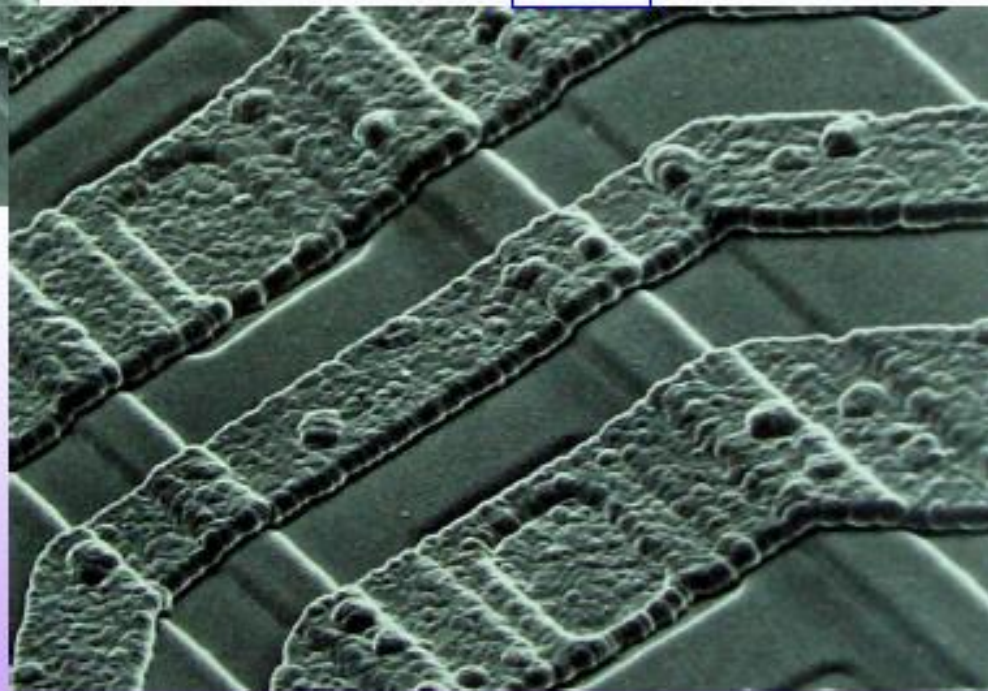
- Low surface contrast
- More BSE  $\Rightarrow$  contributions from within the specimen





0°

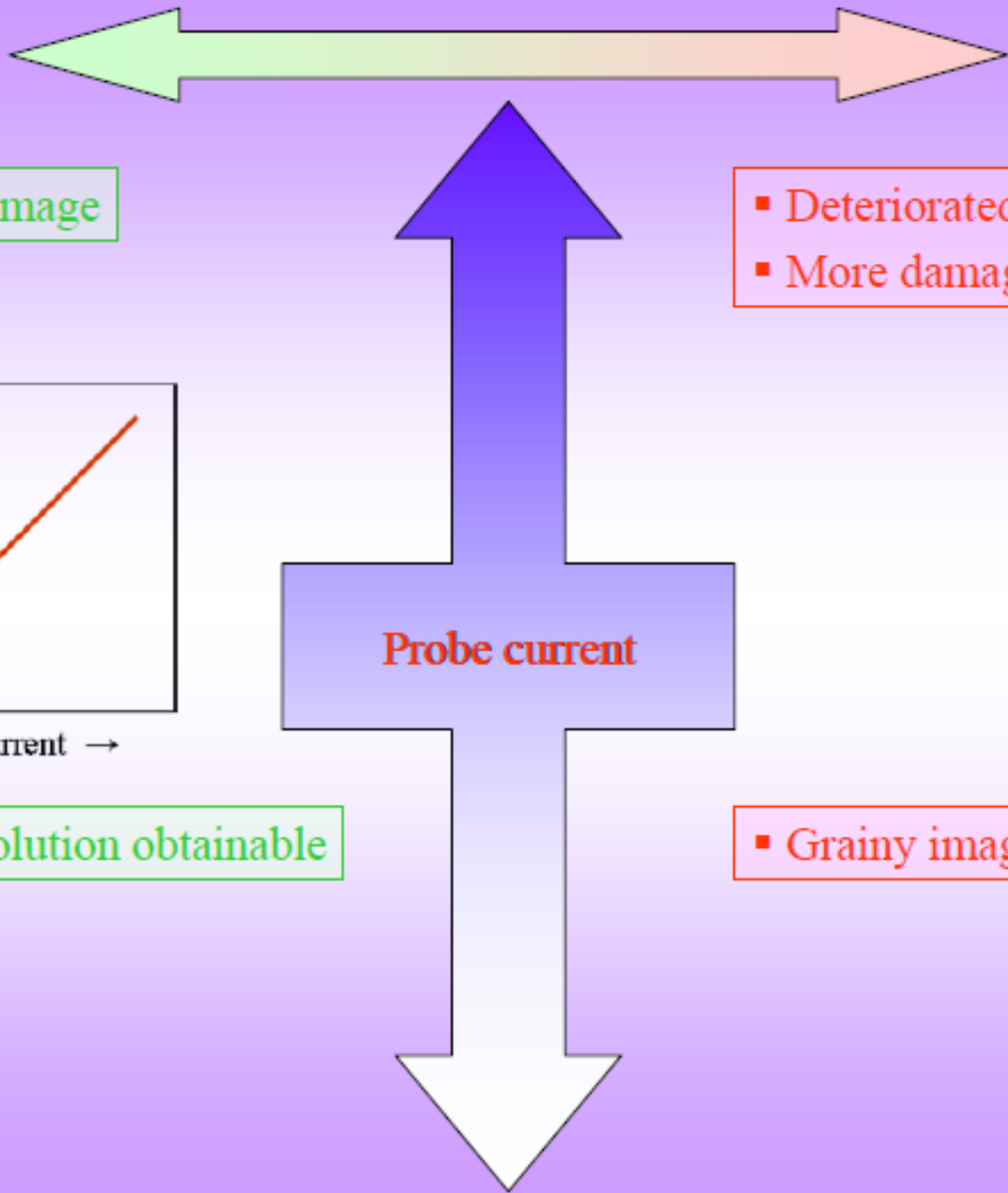
45°



*Specimen: IC chip*

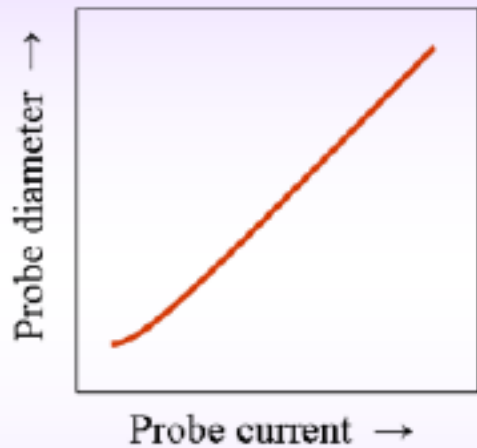
TILT

- Improve quality of SE images
- complete survey of topography
- Stereo images → images at 2 angles



▪ Smooth image

▪ Deteriorated resolution  
▪ More damage

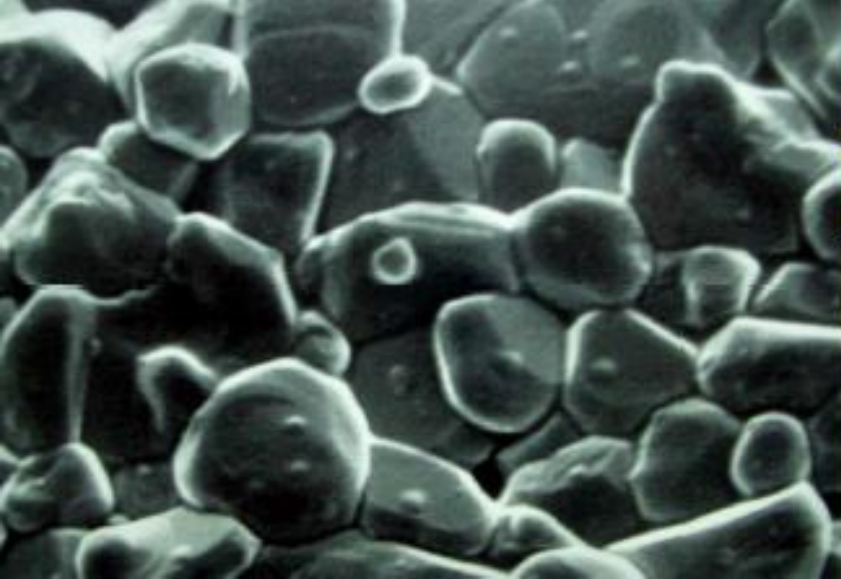


▪ High-resolution obtainable

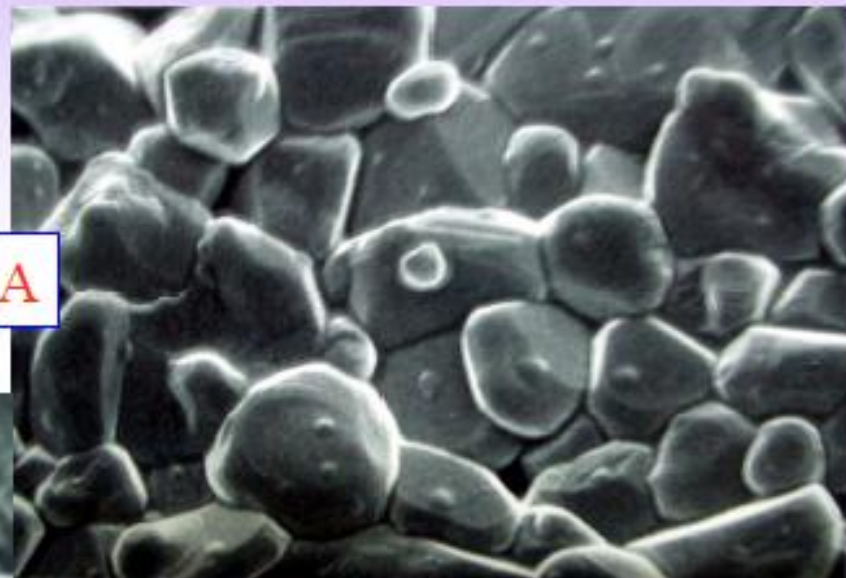
▪ Grainy image



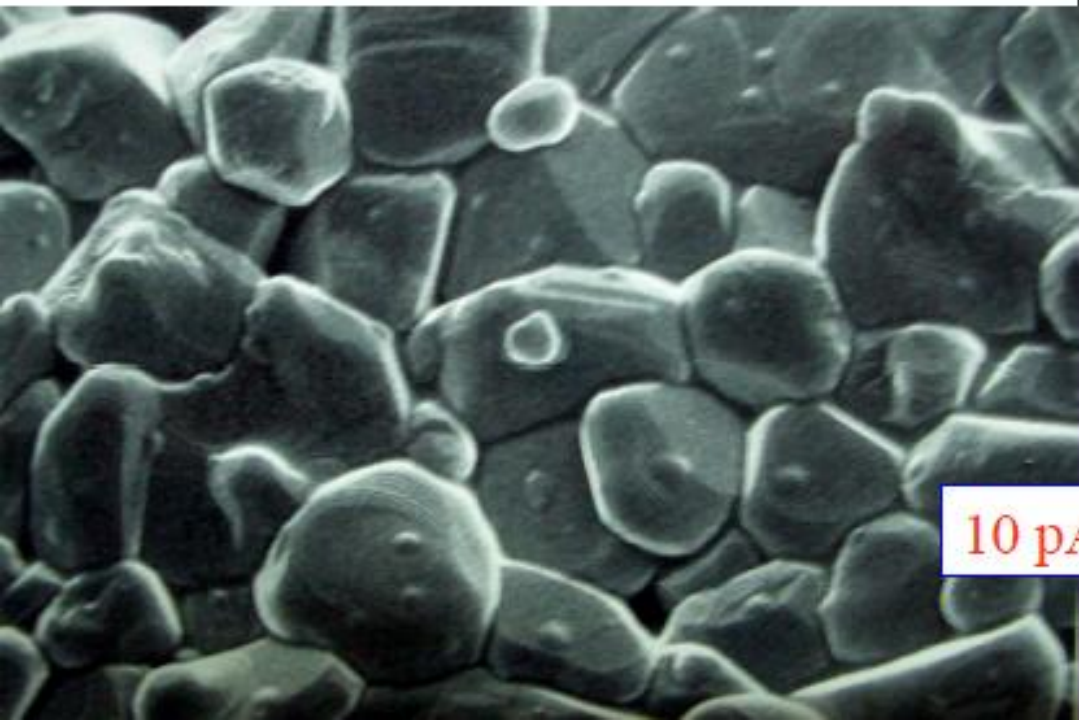
10 kV, 5400 ×



1 nA



0.1 nA



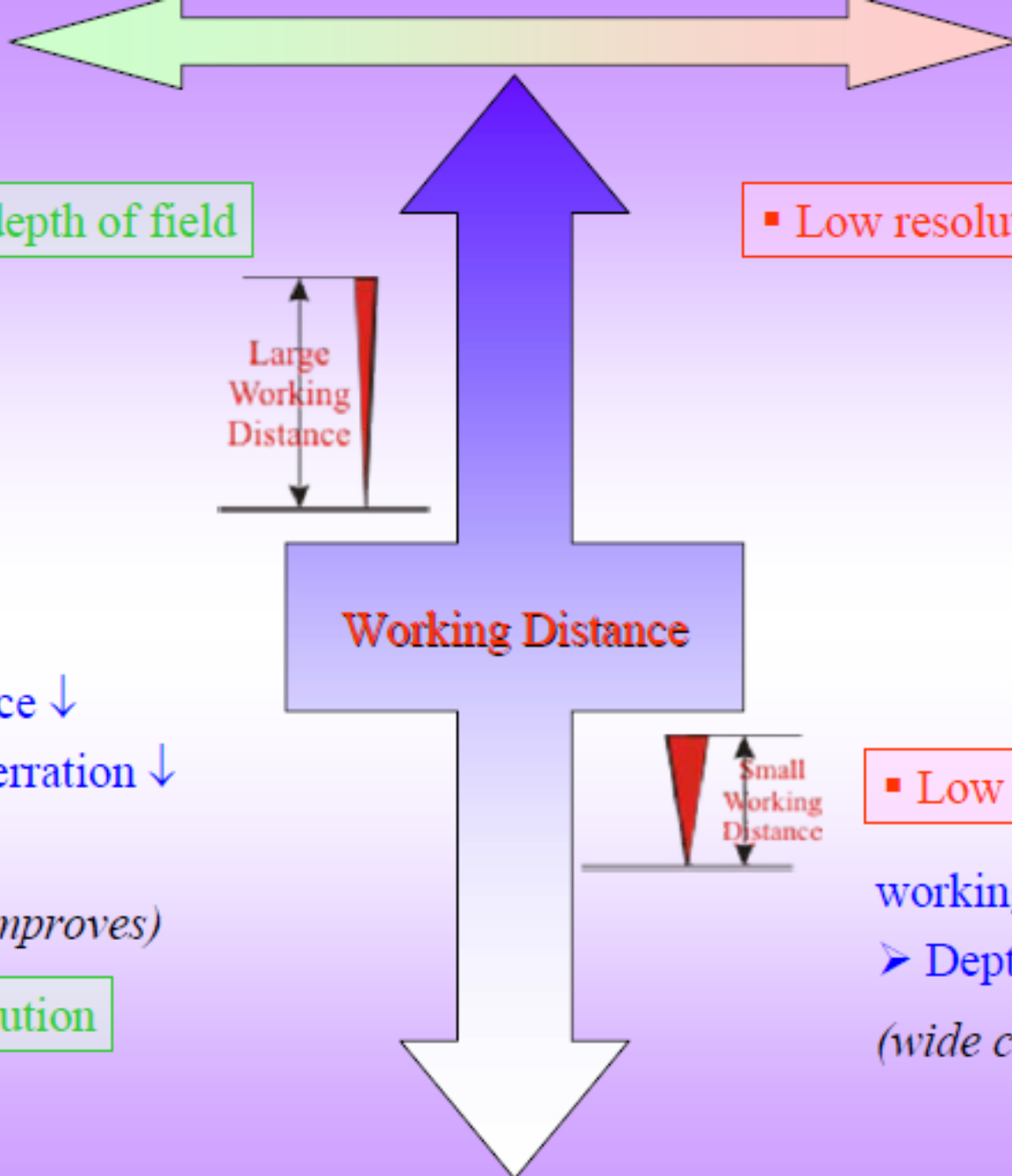
10 pA

*Specimen: Ceramic*

↓ Probe current

- ↑ image sharpness
- ↓ surface smoothness





▪ Greater depth of field

▪ Low resolution

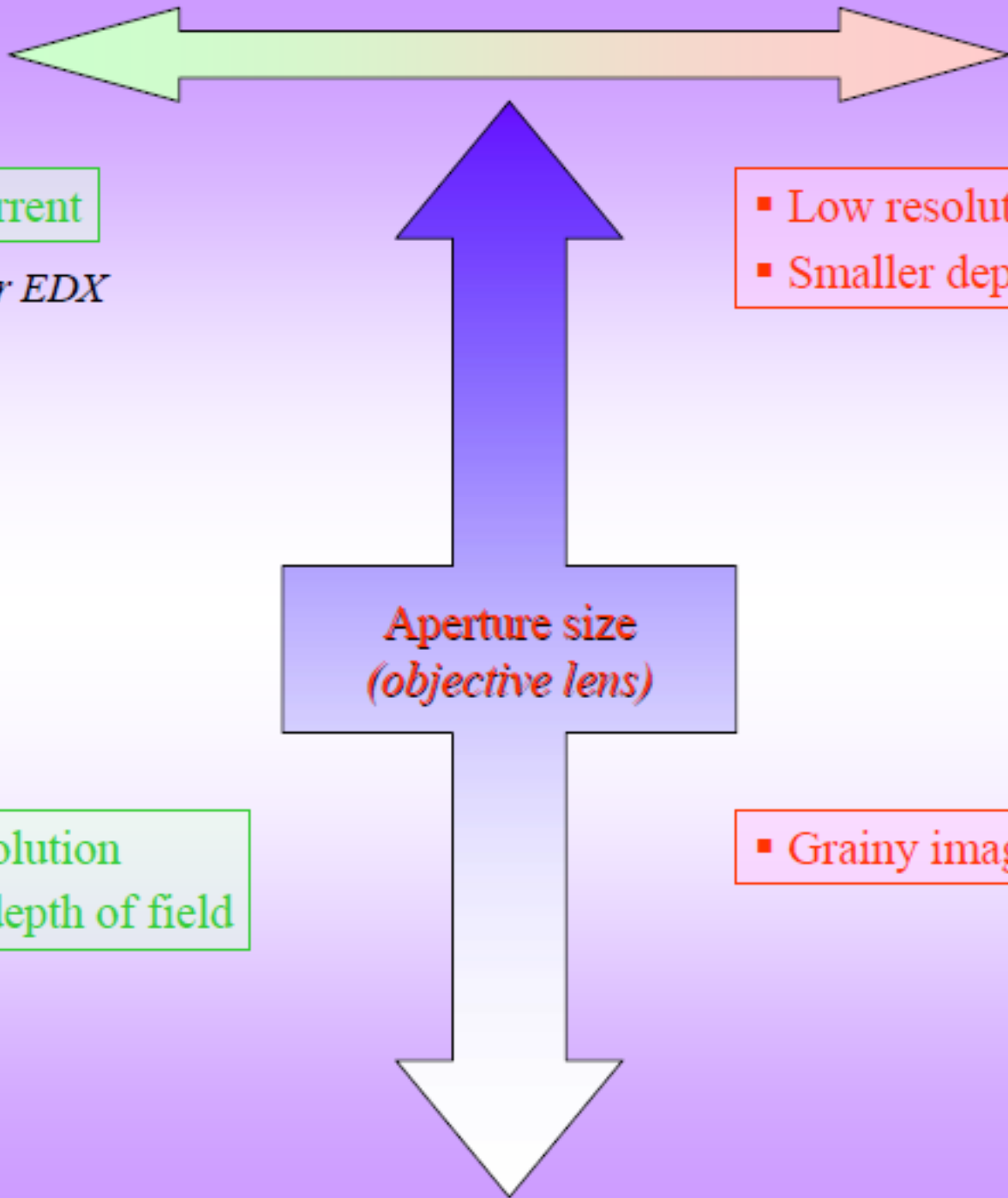
working distance ↓  
➤ spherical aberration ↓  
(spot size ↓  
⇒ resolution improves)

▪ High resolution

▪ Low depth of field

working distance ↓  
➤ Depth of field ↓  
(wide cone of electrons)

The working distance is the distance between the final condenser lens and the specimen



▪ Large current

*e.g. Better for EDX*

▪ Low resolution

▪ Smaller depth of field

**Aperture size**  
*(objective lens)*

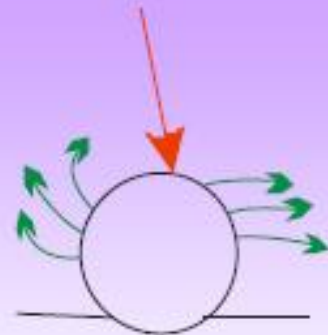
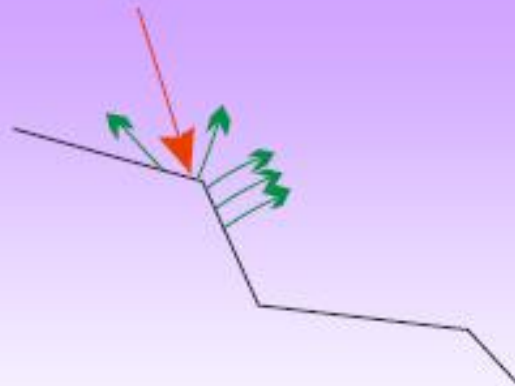
▪ High resolution

▪ Greater depth of field

▪ Grainy image

# Edge Effect

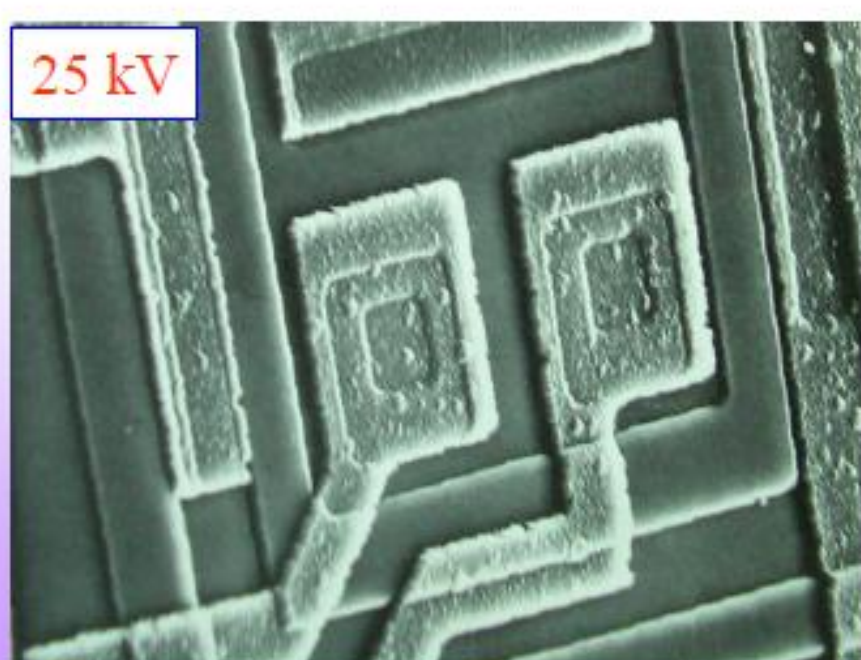
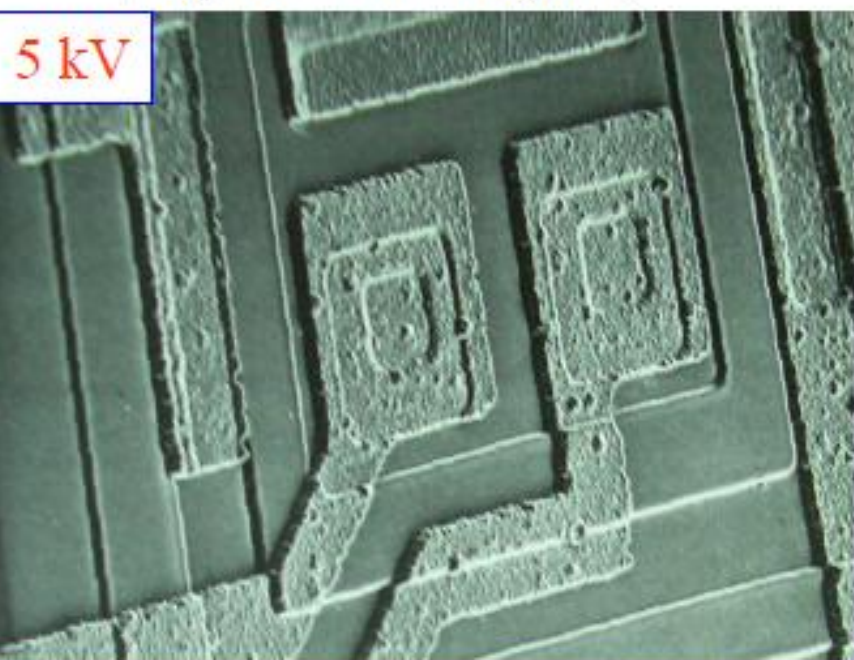
↑ SE emission from protrusions and circumferences ⇒ appear bright



↑ Accelerating voltage

- Greater the edge effect  
(edges become brighter)

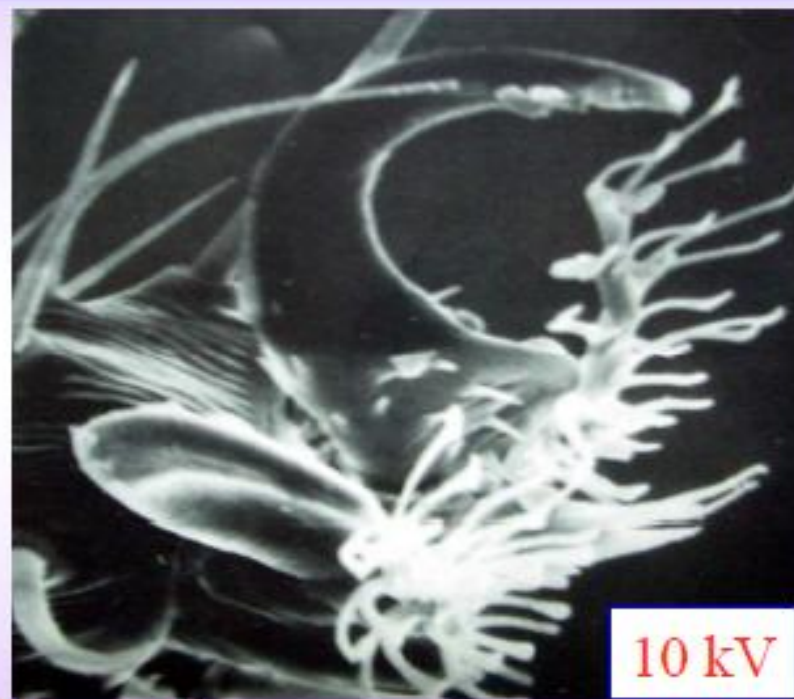
Tilt: 50°, 720 ×



Specimen: IC chip

## Charging

- Due to low conductivity of sample
- Coating with a conducting material to avoid charging
- To ↓ charging → ↓ Voltage, ↓ probe current, tilt specimen



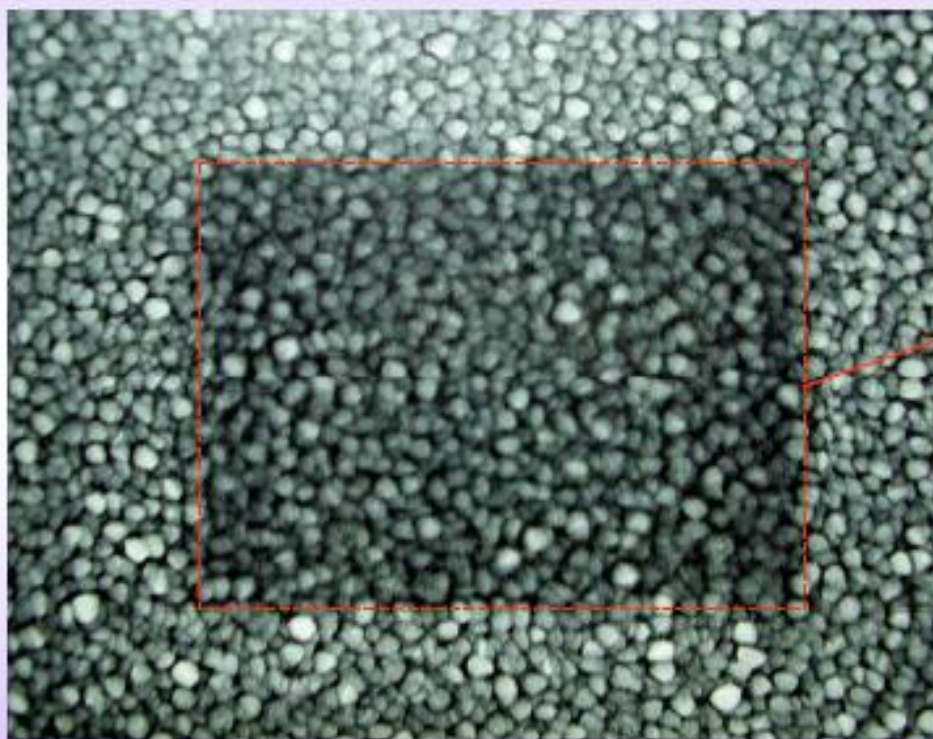
*Specimen: Foreleg of vinegar fly*

- ↑ Accelerating voltage
- ↑ Charging



## Contamination

- Due to residual gas in the vicinity of the electron probe
- Leads to reduced contrast and loss in image sharpness
- Usually caused by scanning a small region for long time



Contamination

5 kV

18000 ×